SENSITRON SEMICONDUCTOR

SHD125212 SHD125212P SHD125212N SHD125212D

TECHNICAL DATA DATA SHEET 4157, REV. A

HERMETIC POWER SCHOTTKY RECTIFIER Very Low Forward Voltage

Applications:

• Switching Power Supply • Converters • Free-Wheeling Diodes • Polarity Protection Diode

Features:

- Soft Reverse Recovery at Low and High Temperature
- Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- High Surge Capacity
- Guard Ring for Enhanced Durability and Long Term Reliability
- Guaranteed Reverse Avalanche Characteristics

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V _{RWM}	-	45	V
Max. Average Forward Current	I _{F(AV)} 50% duty cycle, rectangular wave form (Single/Doubler)		15	A
Max. Average Forward Current	I _{F(AV)}	I _{F(AV)} 50% duty cycle, rectangular wave form (Common Cathode/Common Anode)		A
Max. Peak One Cycle Non- Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine wave (per leg)	200	A
Max. Thermal Resistance	$R_{\theta JC}$	(Single)	1.45	°C/W
Max. Thermal Resistance	R _{θJC}	(Common Cathode/Common Anode/Doubler) (per leg)	0.72	°C/W
Max. Junction Temperature	TJ	-	-65 to +150	°C
Max. Storage Temperature	T _{stg}	-	-65 to +150	°C

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	V _{F1}	@ 15A, Pulse, T _J = 25 °C	0.65	V
		(per leg)		
	V _{F2}	@ 15A, Pulse, T _J = 125 °C	0.60	V
		(per leg)		
Max. Reverse Current	I _{R1}	$@V_R = 45V$, Pulse,	1.5	mA
		$T_J = 25 \ ^{\circ}C$ (per leg)		
	I _{R2}	$@V_R = 45V$, Pulse,	70	mA
		$T_J = 125 \ ^{\circ}C \ (per leg)$		
Max. Junction Capacitance	CT	@V _R = 5V, T _C = 25 °C	800	pF
		f _{SIG} = 1MHz,		
		$V_{SIG} = 50 \text{mV} (\text{p-p}) (\text{per leg})$		

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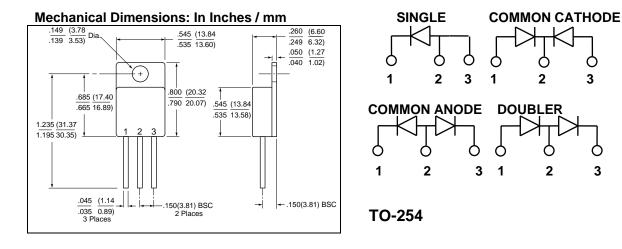
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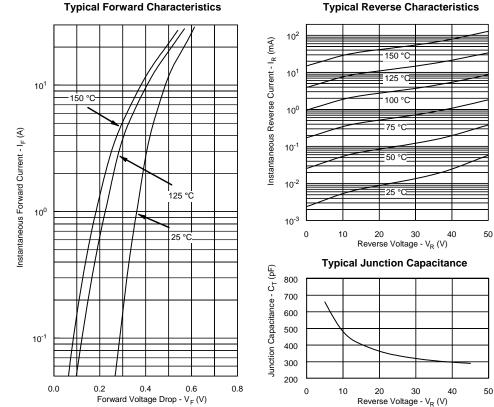
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PINOUT TABLE

PIN 1	PIN 2	PIN 3
CATHODE	ANODE	ANODE
ANODE 1	COMMON CATHODE	ANODE 2
CATHODE 1	COMMON ANODE	CATHODE 2
ANODE	CATHODE/ANODE	CATHODE
	CATHODE ANODE 1 CATHODE 1	CATHODEANODEANODE 1COMMON CATHODECATHODE 1COMMON ANODE

Note: The V_f curves shown are for the SD125SA45 un-packaged die only.



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Typical Reverse Characteristics

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